



**MULTI-INNO TECHNOLOGY CO., LTD.**

**www.multi-inno.com**

## **LCD MODULE SPECIFICATION**

**Model : MI0220ZT-1**

This module uses ROHS material

### **For Customer's Acceptance:**

Customer	
Approved	
Comment	

This specification may change without prior notice in order to improve performance or quality. Please contact Multi-Inno for updated specification and product status before design for this product or release of this order.

Revision	1.0
Engineering	
Date	2013-04-27
Our Reference	

## REVISION RECORD

[illegible]



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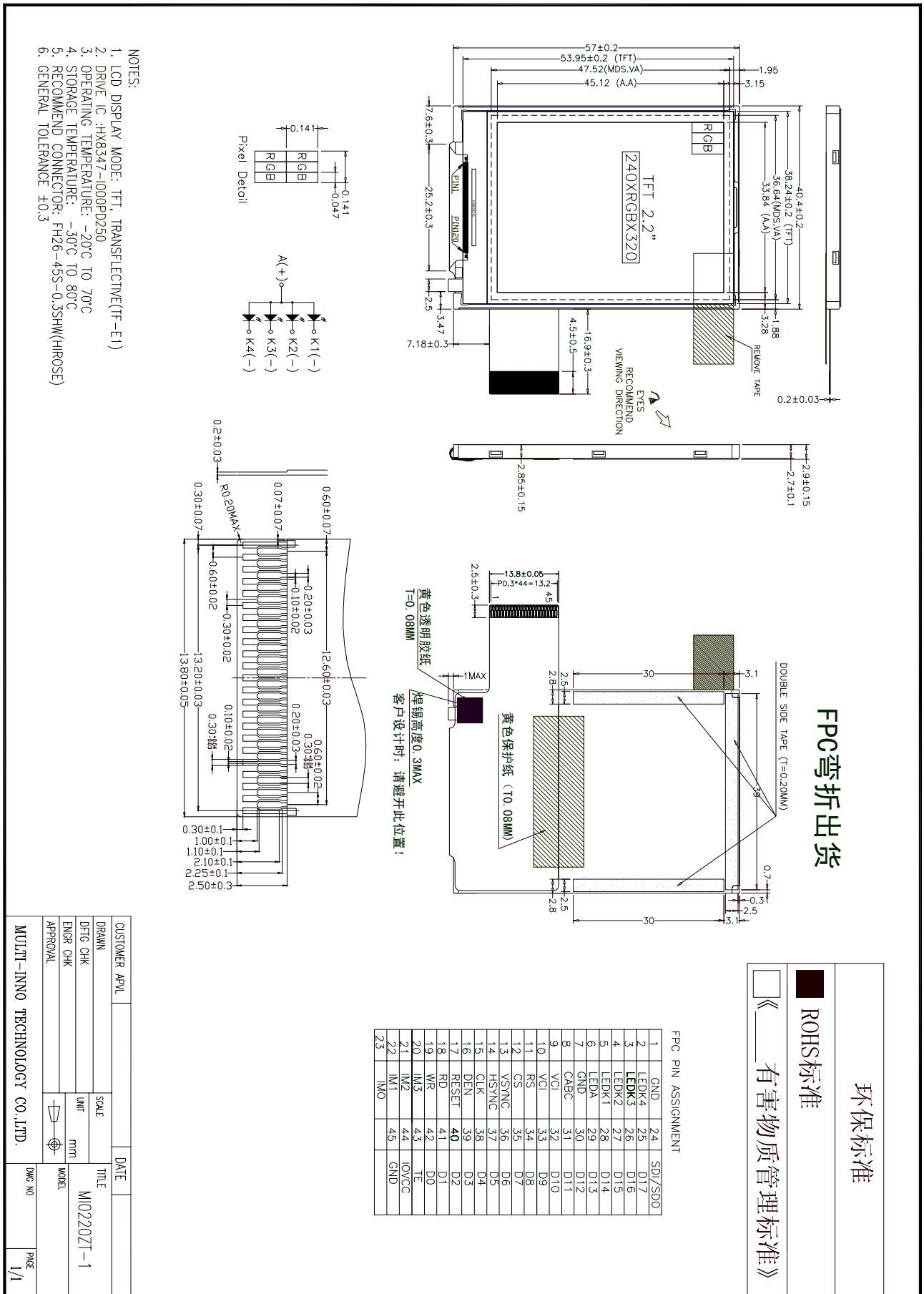
**■ GENERAL INFORMATION**

Item of general information	Contents	Unit
LCD Type	TFT, TRANSFLECTIVE	/
Size	2.2	Inch
Recommended Viewing Direction	6:00	O' Clock
Module area (W × H×T)	40.40×57.00×2.90	mm <sup>3</sup>
Viewing area (W×H)	36.64×47.52	mm <sup>2</sup>
Active area (W×H)	33.84×45.12	mm <sup>2</sup>
Number of Dots	240RGB×320	/
Pixel pitch (W × H)	0.141×0.141	mm <sup>2</sup>
Driver IC	HX8347-I000PD250	/
Interface Type	MPU/SPI+RGB	/
Input voltage	2.8	V
Module Power consumption	205	mw
Colors	262K	/
Backlight Type	4 LEDs	/
Weight	11.9	g

Note 1 : RoHS compliant;

Note 2: LCM weight tolerance: ± 5% .

## EXTERNAL DIMENSIONS





## ■ ABSOLUTE MAXIMUM RATINGS

Parameter of absolute maximum ratings	Symbol	Min	Max	Unit
Supply voltage for logic	VCI/IOVCC	-0.3	4.6	V
Input voltage	VIN	-0.3	IOVCC+0.5	V
Operating temperature	Top	-20	70	°C
Storage temperature	TST	-30	80	°C
Humidity	RH	-	90%(Max60 °C)	RH

Note: Absolute maximum ratings means the product can withstand short-term, NOT more than 120 hours. If the product is a long time to withstand these conditions the life time would be shorter

## ■ ELECTRICAL CHARACTERISTICS

### DC CHARACTERISTICS

Parameter of DC characteristics	Symbol	Min	Typ	Max	Unit
Supply voltage for logic	VCI	2.3	2.8	3.3	V
I/O power supply	IOVCC	1.65	2.8	3.3	V
Input Current	Idd	-	4.6	6.9	mA
Input voltage 'H' level	VIH	0.7IOVCC	-	IOVCC	V
Input voltage 'L' level	VIL	GND	-	0.3IOVCC	V
Output voltage 'H' level	VOH	0.8IOVCC	-	IOVCC	V
Output voltage 'L' level	VOL	GND	-	0.2IOVCC	V

## ■ BACKLIGHT CHARACTERISTICS

Item of backlight characteristics	Symbol	Min.	Typ.	Max.	Unit	Condition
Forward voltage	Vf	2.6	3.0	3.3	V	If=60mA
Number of LED	-	-	4	-	Piece	-
Connection mode	P	-	Parallel	-	-	-

Using condition: constant current driving method If=60mA(+/-10%).

## ■ ELECTRO OPTICAL CHARACTERISTICS

Item of electro-optical characteristics	Symbol	Condition	Min	Typ	Max	Unit	Remark	Note
Response time	Tr+ Tf	$\theta=0^\circ$ $\varnothing=0^\circ$ $T_a=25^\circ\text{C}$	-	30	45	ms	FIG 1.	4
Contrast ratio	Cr		43	86	-	-	FIG 2.	1
Luminance uniformity	$\delta$ WHITE		80	-	-	%	FIG 2.	3
Surface Luminance	Lv		200	250	-	cd/m <sup>2</sup>	FIG 2.	2
Viewing angle range	$\theta$	$\varnothing = 90^\circ$	30	40	-	deg	FIG 3.	6
		$\varnothing = 270^\circ$	70	80	-	deg	FIG 3	
		$\varnothing = 0^\circ$	40	50	-	deg	FIG 3	
		$\varnothing = 180^\circ$	10	20	-	deg	FIG 3	
NTSC ratio	-	-	-	45	-	%	-	-
Reflectance	R%	-	-	6.1	-	%	-	-
CIE (x, y) chromaticity	Red x	$\theta=0^\circ$ $\varnothing=0^\circ$ $T_a=25^\circ\text{C}$	0.5243	0.5743	0.6243	-	FIG 2.	5
	Red y		0.2983	0.3483	0.3983	-		
	Green x		0.2804	0.3304	0.3804	-		
	Green y		0.5153	0.5653	0.6153	-		
	Blue x		0.1077	0.1577	0.2077	-		
	Blue y		0.0690	0.1190	0.1690	-		
	White x		0.2295	0.2895	0.3495	-		
	White y		0.2455	0.3055	0.3655	-		

Notel. Contrast Ratio(CR) is defined mathematically by the following formula. For more information see FIG 2.:

$$\text{Contrast Ratio(CR)} = \frac{\text{Average Surface Luminance with all white pixels (P1, P2, \dots)}}{\text{Average Surface Luminance with all black pixels (P1, P2, \dots)}}$$

Note2. Surface luminance is the LCD surface luminance with all white pixels. For more information see FIG 2.

$L_v$  = Average Surface Luminance with all white pixels (P1, P2, ..... )

Note3. The uniformity in surface luminance ( $\delta$  WHITE) is determined by measuring luminance at each test position, and then dividing the maximum luminance of all white pixels by minimum luminance of all white pixels. For more information see FIG 2.

$$\delta \text{ WHITE} = \frac{\text{Minimum Surface Luminance with all white pixels (P1, P2, .....)}}{\text{Maximum Surface Luminance with all white pixels (P1, P2, ..... )}}$$

Note4. Response time is the time required for the display to transition from White to black(Rise Time,  $T_r$ ) and from black to white(Decay Time,  $T_f$ ). For additional information see FIG 1..

Note5. CIE(x, y) chromaticity is the Center point value. For more information see FIG 2.

Note6. Viewing angle is the angle at which the contrast ratio is greater than a specific value. For TFT module, the specific value of contrast ratio is 10; For monochrome and color stn module, the specific value of contrast ratio is 2.The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG 3.

Note7. For Viewing angle and response time testing, the testing data is base on Autronic-Melchers's ConoScope. Series Instruments. For contrast ratio, Surface Luminance, Luminance uniformity and CIE, the testing data is base on CS-2000 photo detector.

Note8. For TN type TFT transmissive module, Gray scale reverse occurs in the direction of panel viewing angle

FIG.1. The definition of Response Time

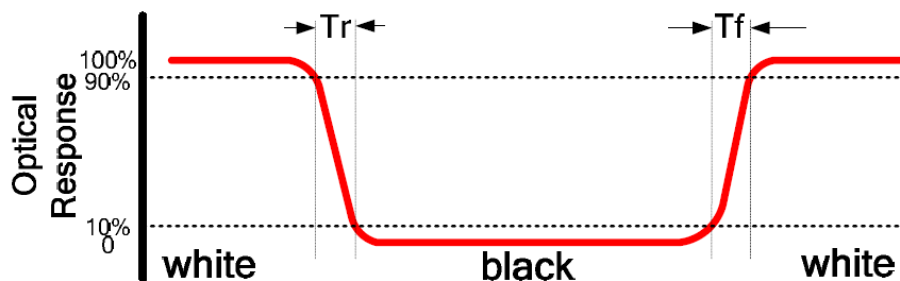


FIG.2. Measuring method for Contrast ratio, surface luminance, Luminance uniformity,CIE (x, y) chromaticity

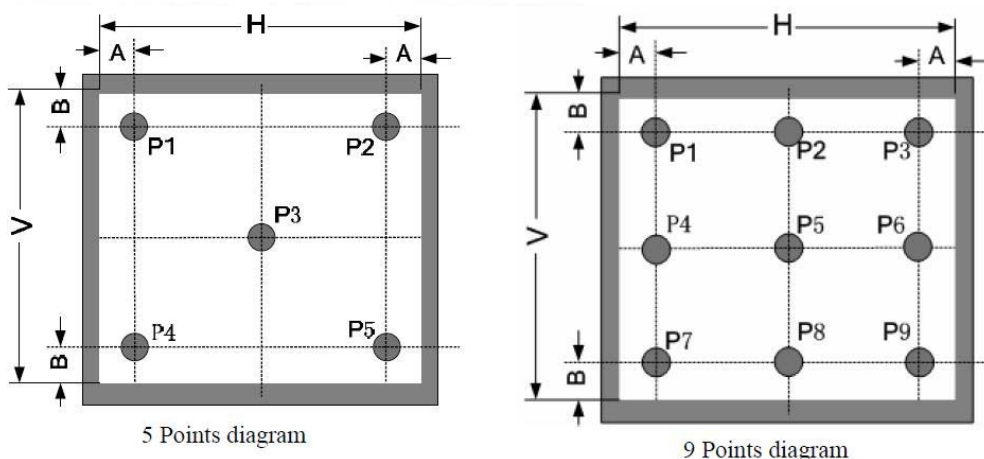




Fig2 Note1 For TFT Module Test point:9 points( as 9 Points diagram )

A :  $H/6$  (if AA size $<4.0$ inch);  $H/10$  (if AA size $\geq 4.0$ inch)

B :  $V/6$  (if AA size $<4.0$ inch);  $V/10$  (if AA size $\geq 4.0$ inch)

H,V : Active Area(AA) size

Measurement instrument: CS-2000; Light spot size  $\varnothing=5$ mm, 350mm distance from the LCD surface to detector lens.

Fig2 Note2 For non-TFT Module and Dot-Matrix type Module

2.1 If the minimum side size is bigger than 20 mm,the testing method is the same as TFT module.

2.2 If the minimum side size is less than 20 mm, then testing 5 point datas (as 5 Points diagram), Both A and B are 5 mm.

2.3 Measurement instrument: CS-2000 is priority selected to measure.

Light spot size  $\varnothing=5$ mm, 350mm distance from the LCD surface to detector lens.

2.4 Measurement instrument : ConoScope will be selected to measure If CS-2000 cannot meet the measurement requirement.

Light spot size  $\varnothing=0.2-2.0$ mm. About 2-3mm distance from the LCD surface to detector lens, but suggest to confirm the best distance on focusing the picture to be clearest when actually measuring.

Fig2 Note3 For non-TFT Module and non-Dot-Matrix type Module

The test point is defined by the fact size and shape of module,but the center point and four edges should be selected.

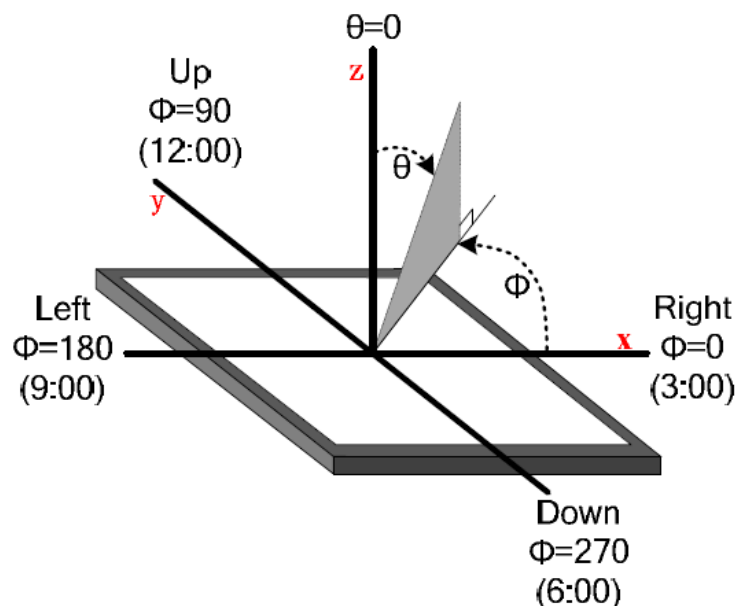
3.1 Measurement instrument: CS-2000 is priority selected to measure..

Light spot size  $\varnothing=5$ mm, 350mm distance from the LCD surface to detector lens.

3.2 Measurement instrument : ConoScope will be selected to measure If CS-2000 cannot meet the measurement requirement.

Light spot size  $\varnothing=0.2-2.0$ mm. About 2-3mm distance from the LCD surface to detector lens, but suggest to confirm the best distance on focusing the picture to be clearest when actually measuring.

**FIG.3. The definition of viewing angle**



## ■ INTERFACE DESCRIPTION

NO.	NAME	I/O or connect to	DESCRIPTION	When not in use
1	GND	Power Supply	Power Ground	-
2	LEDK4	LED DRIVER	LED4(CATHODE)	-
3	LEDK3	LED DRIVER	LED4(CATHODE)	-
4	LEDK2	LED DRIVER	LED2(CATHODE)	-
5	LEDK1	LED DRIVER	LED1(CATHODE)	-
6	LEDA	LED DRIVER	LEDA(ANODE)	-
7	GND	Power Supply	Power Ground	-
8	CABC	O Host processor	CABC backlight control PWM signal output	OPEN
9~10	VCI	Power supply	Analog power supply	-
11	RS	I Host processor	(RS) Command / parameter or display data selection pin.	IOVCC or GND
12	CS	I Host processor	Chip select signal. Low: chip can be accessed; High: chip cannot be accessed.	GND
13	VSYNC	I Host processor	Vertical synchronizing signal in RGB interface.	GND
14	HSYNC	I Host processor	Horizontal synchronizing signal in RGB interface.	GND
15	CLK	I Host processor	Data enable signal in RGB interface.	GND
16	DEN	I Host processor	A data ENABLE signal in RGB I/F mode.	GND
17	RESET	I Host processor or reset circuit	Reset pin. Setting either pin low initializes the LSI. Must be reset after power is supplied.	-
18	RD	I Host processor	(RD) Read enable pin I80 parallel bus system interface.	IOVCC or GND
19	WR	I Host processor	(NWR) Write enable pin I80 parallel bus system interface.(SCL) server as serial data clock in serial bus system interface when IFSEL=0.	IOVCC or GND
20	IM3	I Host processor	System interface select. For the detail,please refer to NOTE1	IOVCC or GND
21	IM2			IOVCC or GND
22	IM1			IOVCC or GND
23	IM0			IOVCC or GND
24	SDI/SDO	I Host processor	Serial data input pin and output pin(SDO) in serial bus system interface I.Serial data input pin (SDI) in serial bus system interface II.The data is inputted on the rising edge of the SCL signal.	GND
25~42	DB17~0	I/O Host processor	18-bit bi-directional data bus.	OPEN/ GND
43	TE	O Host processor	Tearing effect output.	OPEN
44	IOVCC	Power Supply	Digital IO Pad power supply	-
45	GND	Power Supply	Power Ground	-

**Note1:**

IM3	IM2	IM1	IM0	Interface	DNC_SCL	NWR_SCL	Data Bus use	
							Register/Content	GRAM
0	0	0	0	8080 MCU 16-bit parallel type I	DNC	NWR	D7-D0	D15-D0: 16-bit data
0	0	0	1	8080 MCU 8-bit parallel type I	DNC	NWR	D7-D0	D7-D0: 8-bit data
0	0	1	0	8080 MCU 16-bit parallel type II	DNC	NWR	D8-D1	D17-10, D8-D1: 16-bit data
0	0	1	1	8080 MCU 8-bit parallel type II	DNC	NWR	D17-D10	D17-D10: 8-bit data
0	1	0	ID	3-wire serial interface	-	SCL		SDA
0	1	1	-	4-wire serial interface	DNC	SCL		SDA
1	0	0	0	8080 MCU 18-bit parallel type I	DNC	NWR	D7-D0	D17-D0: 18-bit data
1	0	0	1	8080 MCU 9-bit parallel type I	DNC	NWR	D7-D0	D8-D0: 9-bit data
1	0	1	0	8080 MCU 18-bit parallel type II	DNC	NWR	D8-D1	D17-D0: 18-bit data
1	0	1	1	8080 MCU 9-bit parallel type II	DNC	NWR	D17-D10	D17-D9: 9-bit data
1	1	0	ID	3-wire serial interface II	-	SCL		SDI/SDO
1	1	1	-	4-wire serial interface II	DNC	SCL		SDI/SDO
Other Setting				Setting Invalid				

**■ REFERENCE APPLICATION CIRCUIT**

Please consult our technical department for detail information.

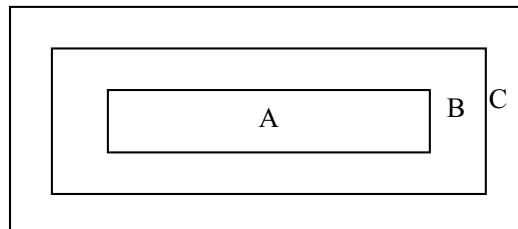
**■ RELIABILITY TEST CONDITIONS**

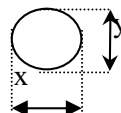
No.	Test Item	Test Condition	Inspection after test
1	High Temperature Storage	$80 \pm 2^{\circ}\text{C}/200$ hours	Inspection after 2~4hours storage at room temperature, the sample shall be free from defects: 1.Air bubble in the LCD; 2.Sealleak; 3.Non-display; 4.missing segments; 5.Glass crack; 6.Current Idd is twice higher than initial value.
2	Low Temperature Storage	$-30 \pm 2^{\circ}\text{C}/200$ hours	
3	High Temperature Operating	$70 \pm 2^{\circ}\text{C}/120$ hours	
4	Low Temperature Operating	$-20 \pm 2^{\circ}\text{C}/120$ hours	
5	Temperature Cycle storage	$-20 \pm 2^{\circ}\text{C} \sim 25 \sim 70 \pm 2^{\circ}\text{C} \times 10$ cycles	
6	Damp proof Test operating	$50^{\circ}\text{C} \pm 5^{\circ}\text{C} \times 90\%\text{RH}/120$ hours	
7	Vibration Test	Frequency: 10Hz~55Hz~10Hz Amplitude: 1.5mm, X, Y, Z direction for total 3hours (Packing condition)	
8	Dropping test	Drop to the ground from 1m height, one time, every side of carton. (Packing condition)	
9	ESD test	Voltage: $\pm 8\text{KV}$ R: $330\Omega$ C: 150pF Air discharge, 10time	

## Remark:

- 1.The test samples should be applied to only one test item.
- 2.Sample size for each test item is 5~10pcs.
- 3.For Damp Proof Test, Pure water(Resistance $>10\text{M}\Omega$ ) should be used.
- 4.In case of malfunction defect caused by ESD damage, if it would be recovered to normal state after resetting, it would be judged as a good part.
- 5.EL evaluation should be excepted from reliability test with humidity and temperature: Some defects such as black spot/blemish can happen by natural chemical reaction with humidity and Fluorescence EL has.
- 6.Failure Judgment Criterion: Basic Specification, Electrical Characteristic, Mechanical Characteristic, Optical Characteristic.

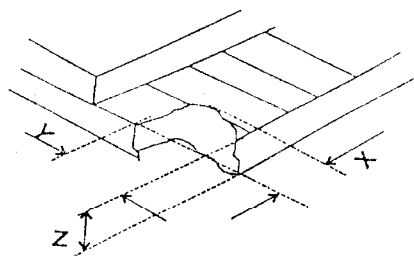
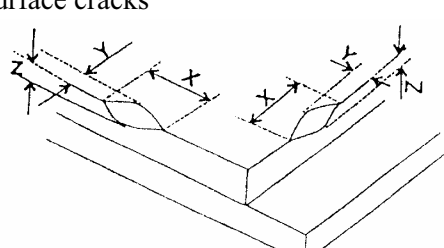
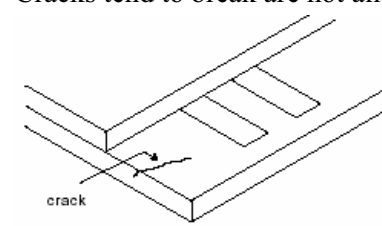
## ■ INSPECTION CRITERION

OUTGOING QUALITY STANDARD	PAGE 1 OF 4
TITLE:FUNCTIONAL TEST & INSPECTION CRITERIA	MDS Product
<p>This specification is made to be used as the standard acceptance/rejection criteria for Color mobile phone LCM.</p> <p>1 Sample plan</p> <p>Sampling plan according to GB/T2828.1-2003/ISO 2859-1: 1999 and ANSI/ASQC Z1.4-1993, normal level 2 and based on:</p> <p>Major defect: AQL 0.65</p> <p>Minor defect: AQL 1.5</p> <p>2. Inspection condition</p> <p>Viewing distance for cosmetic inspection is about 30cm with bare eyes, and under an environment of 20~40W light intensity, all directions for inspecting the sample should be within 45°against perpendicular line.</p> <p>3. Definition of inspection zone in LCD.</p> <div data-bbox="485 1142 1005 1370" data-label="Diagram">  </div> <p>Zone A: character/Digit area</p> <p>Zone B: viewing area except Zone A (ZoneA+ZoneB=minimum Viewing area)</p> <p>Zone C: Outside viewing area (invisible area after assembly in customer's product)</p> <p>Fig.1 Inspection zones in an LCD.</p> <p>Note: As a general rule, visual defects in Zone C are permissible, when it is no trouble for quality and assembly of customer's product.</p>	

OUTGOING QUALITY STANDARD			PAGE 2 OF 4																										
TITLE:FUNCTIONAL TEST & INSPECTION CRITERIA			MDS Product																										
4. Inspection standards																													
4.1 Major Defect																													
Item No	Items to be inspected	Inspection Standard		Classification of defects																									
4.1.1	All functional defects	1) No display 2) Display abnormally 3) Missing vertical, horizontal segment 4) Short circuit 5) Back-light no lighting, flickering and abnormal lighting.		Major																									
4.1.2	Missing	Missing component																											
4.1.3	Outline dimension	Overall outline dimension beyond the drawing is not allowed.																											
4.2 Cosmetic Defect																													
Item No	Items to be inspected	Inspection Standard		Classification of defects																									
4.2.1	Clear Spots	For dark/white spot, sizeΦis defined as $\Phi= \frac{(x+y)}{2}$ 		Minor																									
	Black and white Spot defect Pinhole, Foreign Particle, Dirt under polarizer	1.																											
		<table><tr><th rowspan="2">Size(mm) \ Zone</th><th colspan="3">Acceptable Qty</th></tr><tr><th>A</th><th>B</th><th>C</th></tr><tr><td>Φ≤0.10</td><td colspan="3">Ignore</td></tr><tr><td>0.10 &lt; Φ≤0.15</td><td colspan="3">2</td></tr><tr><td>0.15 &lt; Φ≤0.20</td><td colspan="3">1</td></tr><tr><td>Φ &gt; 0.20</td><td colspan="3">0</td></tr></table>			Size(mm) \ Zone	Acceptable Qty			A	B	C	Φ≤0.10	Ignore			0.10 < Φ≤0.15	2			0.15 < Φ≤0.20	1			Φ > 0.20	0				
		Size(mm) \ Zone	Acceptable Qty																										
			A		B	C																							
		Φ≤0.10	Ignore																										
		0.10 < Φ≤0.15	2																										
	0.15 < Φ≤0.20	1																											
	Φ > 0.20	0																											
	Dim Spots	2.																											
<table><tr><th rowspan="2">2. Zone \ Size(mm)</th><th colspan="3">Acceptable Qty</th></tr><tr><th>A</th><th>B</th><th>C</th></tr><tr><td>Φ≤0.2</td><td colspan="3">Ignore</td></tr><tr><td>0.20 &lt; Φ≤0.40</td><td colspan="3">3</td></tr><tr><td>0.40 &lt; Φ≤0.60</td><td colspan="3">2</td></tr><tr><td>0.60 &lt; Φ≤0.80</td><td colspan="3">1</td></tr><tr><td>0.80 &lt; Φ</td><td colspan="3">0</td></tr></table>		2. Zone \ Size(mm)	Acceptable Qty			A	B	C	Φ≤0.2	Ignore			0.20 < Φ≤0.40	3			0.40 < Φ≤0.60	2			0.60 < Φ≤0.80	1			0.80 < Φ	0			
2. Zone \ Size(mm)			Acceptable Qty																										
		A	B	C																									
Φ≤0.2	Ignore																												
0.20 < Φ≤0.40	3																												
0.40 < Φ≤0.60	2																												
0.60 < Φ≤0.80	1																												
0.80 < Φ	0																												
Circle shaped and dim edged defects																													



OUTGOING QUALITY STANDARD					PAGE 3 OF 4		
TITLE: FUNCTIONAL TEST & INSPECTION CRITERIA					MDS Product		
4.2. Cosmetic Defect							
Item No	Items to be inspected	Inspection Standard					Classification of defects
4.2.2	Line defect Black line, White line, Foreign material under polarizer,	Size(mm)		Acceptable Qty			Minor
		L(Length)	W(Width)	Zone			
				A	B	C	
		Ignore	$W \leq 0.02$	Ignore		Ignore	
		$L \leq 3.0$	$0.02 < W \leq 0.03$	2			
		$L \leq 2.0$	$0.03 < W \leq 0.05$	1			
			$0.05 < W$	Define as spot defect			
4.2.3	Polarizer scratch	If the Polarizer scratch can be seen after mobile phone cover assembling or in the operating condition, judge by the line defect of 4.2.2.  If the Polarizer scratch can be seen only in non-operating condition or some special angle, judge by the following.					Minor
		Size(mm)		Acceptable Qty			
		L(Length)	W(Width)	Zone			
				A	B	C	
		Ignore	$W \leq 0.03$	Ignore		Ignore	
		$5.0 < L \leq 10.0$	$0.03 < W \leq 0.05$	2			
		$L \leq 5.0$	$0.05 < W \leq 0.08$	1			
	$0.08 < W$	0					
4.2.4	Polarize Air bubble	Air bubbles between glass & polarizer					Minor
		2. Zone Size(mm)	Acceptable Qty				
			A	B	C		
		$\Phi \leq 0.2$	Ignore		Ignore		
		$0.20 < \Phi \leq 0.30$	2				
		$0.30 < \Phi \leq 0.50$	1				
		$0.50 < \Phi$	0				

OUTGOING QUALITY STANDARD		PAGE 4 OF 4							
TITLE:FUNCTIONAL TEST & INSPECTION CRITERIA		MDS Product							
4.3. Cosmetic Defect									
Item No	Items to be inspected	Inspection Standard	Classification of defects						
4.3.5	Glass defect	(i) Chips on corner  <table border="1"><tr><td>X</td><td>Y</td><td>Z</td></tr><tr><td>≤2.0</td><td>≤S</td><td>Disregard</td></tr></table> <p>Notes: S=contact pad length Chips on the corner of terminal shall not be allowed to extend into the ITO pad or expose perimeter seal.</p>	X	Y	Z	≤2.0	≤S	Disregard	Minor
		X	Y	Z					
		≤2.0	≤S	Disregard					
(ii)Usual surface cracks  <table border="1"><tr><td>X</td><td>Y</td><td>Z</td></tr><tr><td>≤3.0</td><td>&lt;Inner border line of the seal</td><td>Disregard</td></tr></table>	X	Y	Z	≤3.0	<Inner border line of the seal	Disregard	Minor		
X	Y	Z							
≤3.0	<Inner border line of the seal	Disregard							
(iii) Crack Cracks tend to break are not allowed. 	Major								
4.3.6	Parts alignment	1) Not allow IC and FPC/heat-seal lead width is more than 50% beyond lead pattern. 2) Not allow chip or solder component is off center more than 50% of the pad outline.	Minor						
4.3.7	SMT	According to the <Acceptability of electronic assemblies> IPC-A-610C class 2 standard. Component missing or function defect are Major defect, the others are Minor defect.							



## ■ PRECAUTIONS FOR USING LCD MODULES

### 1 Handling Precautions

- 1.1 The display panel is made of glass and polarizer. As glass is fragile. It tends to become or chipped during handling especially on the edges. Please avoid dropping or jarring. Do not subject it to a mechanical shock by dropping it or impact.
- 1.2 If the display panel is damaged and the liquid crystal substance leaks out, be sure not to get any in your mouth. If the substance contacts your skin or clothes, wash it off using soap and water
- 1.3 Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary. Do not touch the display with bare hands. This will stain the display area and degraded insulation between terminals (some cosmetics are determined to the polarizer)
- 1.4 The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully. Do not touch, push or rub the exposed polarizers with anything harder than an HB pencil lead (glass, tweezers, etc.). Do not put or attach anything on the display area to avoid leaving marks on it. Condensation on the surface and contact with terminals due to cold will damage, stain or dirty the polarizer. After products are tested at low temperature they must be warmed up in a container before coming in to contact with room temperature air.
- 1.5 If the display surface becomes contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If it is heavily contaminated, moisten cloth with one of the following solvents
  - Isopropyl alcohol
  - Ethyl alcoholDo not scrub hard to avoid damaging the display surface.
- 1.6 Solvents other than those above-mentioned may damage the polarizer. Especially, do not use the following.
  - Water
  - Ketone
  - Aromatic solventsWipe off saliva or water drops immediately, contact with water over a long period of time may cause deformation or color fading. Avoid contact with oil and fats.
- 1.7 Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.
- 1.8 Install the LCD Module by using the mounting holes. When mounting the LCD module make sure it is free of twisting, warping and distortion. In particular, do not forcibly pull or bend the I/O cable or the backlight cable.
- 1.9 Do not attempt to disassemble or process the LCD module.
- 1.10 NC terminal should be open. Do not connect anything.
- 1.11 If the logic circuit power is off, do not apply the input signals.
- 1.12 Electro-Static Discharge Control, Since this module uses a CMOS LSI, the same careful attention should be paid to electrostatic discharge as for an ordinary CMOS IC. To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
  - Before removing LCM from its packing case or incorporating it into a set, be sure the module and your body have the same electric potential. Be sure to ground the body when handling the LCD modules.

- Tools required for assembling, such as soldering irons, must be properly grounded. Make certain the AC power source for the soldering iron does not leak. When using an electric screwdriver to attach LCM, the screwdriver should be of ground potentiality to minimize as much as possible any transmission of electromagnetic waves produced sparks coming from the commutator of the motor.

- To reduce the amount of static electricity generated, do not conduct assembling and other work under dry conditions. To reduce the generation of static electricity be careful that the air in the work is not too dry. A relative humidity of 50%-60% is recommended. As far as possible make the electric potential of your work clothes and that of the work bench the ground potential.

- The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.

1.13 Since LCM has been assembled and adjusted with a high degree of precision, avoid applying excessive shocks to the module or making any alterations or modifications to it

- Do not alter modify or change the shape of the tab on the metal frame.

- Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.

Do not damage or modify the pattern writing on the printed circuit board.

- Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal connector

- Except for soldering the interface, do not make any alterations or modifications with a soldering iron.

- Do not drop, bend or twist the LCM.

## 2 Handling precaution for LCM

2.1 LCM is easy to be damaged. Please note below and be careful for handling.

### 2.2 Correct handling:

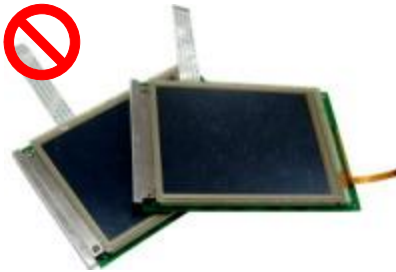


As above picture, please handle with anti-static gloves around LCM edges.

### 2.3 Incorrect handling:



Please don't touch IC directly.



Please don't stack LCM.



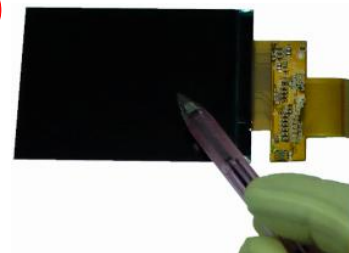
Please don't hold the surface of panel.



Please don't stretch interface of output, such as FPC cable.



Please don't hold the surface of IC.



Please don't operate with sharp stick such as pens.

### 3 Storage Precautions

3.1 When storing the LCD modules, the following precaution are necessary.

- 3.1.1 Store them in a sealed polyethylene bag. If properly sealed, there is no need for the desiccant
- 3.1.2 Store them in a dark place. Do not expose to sunlight or fluorescent light, keep the temperature between 0°C and 35°C, and keep the relative humidity between 40%RH and 60%RH
- 3.1.3 The polarizer surface should not come in contact with any other objects (We advise you to store them in the anti-static electricity container in which they were shipped).

3.2 Transportation Precautions

- 3.2.1 During shipment, please handle with care. The packaging bag can not be broken, step on trap. Packaging Carton layer height can not be over two meters.
- 3.2.2 The transportation process should pay attention to the waterproof and moisture-proof measures. Product can not be watering. Ethylene sealed bags can not be unsealed.

3.3 Others

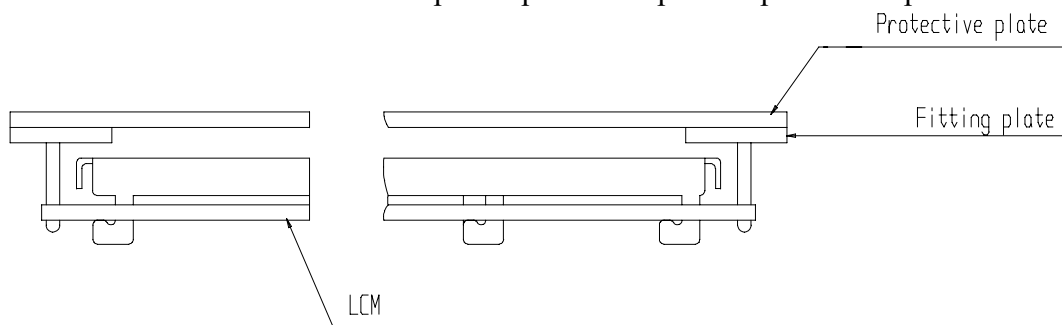
- 3.3.1 Liquid crystals solidify under low temperature (below the storage temperature range) leading to defective orientation or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subject to a low temperature.
- 3.3.2 If the LCD modules have been operating for a long time showing the same display patterns, the display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. A normal operating status can be regained by suspending use for some time. It should be noted that this phenomenon does not adversely affect performance reliability.
- 3.3.3 To minimize the performance degradation of the LCD modules resulting from destruction caused by static electricity etc., exercise care to avoid holding the following sections when handling the modules.
  - 3.3.3.1 - Exposed area of the printed circuit board.
  - 3.3.3.2 -Terminal electrode sections.

### 4 USING LCD MODULES

4.1 Installing LCD Modules

The hole in the printed circuit board is used to fix LCM as shown in the picture below. Attend to the following items when installing the LCM.

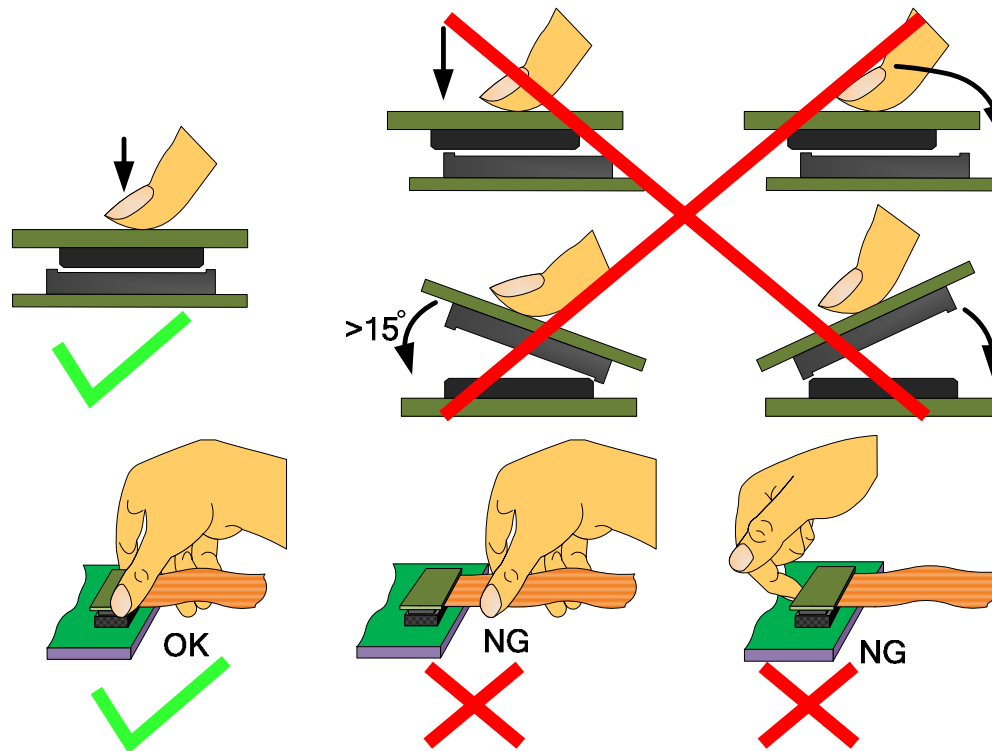
4.1.1 Cover the surface with a transparent protective plate to protect the polarizer and LC cell.



4.1.2 When assembling the LCM into other equipment, the spacer to the bit between the LCM and the fitting plate should have enough height to avoid causing stress to the module surface, refer to the individual specifications for measurements. The measurement tolerance should be  $\pm 0.1\text{mm}$

#### 4.2 Precaution for assemble the module with BTB connector:

Please note the position of the male and female connector position, don't assemble or assemble like the method which the following picture shows



### 4.3 Precaution for soldering the LCM

	Manual soldering	Machine drag soldering	Machine press soldering
No RoHS Product	290°C ~350°C. Time : 3-5S.	330°C ~350°C. Speed : 4-8 mm/s.	300°C ~330°C. Time : 3-6S. Press: 0.8~1.2Mpa
RoHS Product	340°C ~370°C. Time : 3-5S.	350°C ~370°C. Time : 4-8 mm/s.	330°C ~360°C. Time : 3-6S. Press: 0.8~1.2Mpa

4.3.1 If soldering flux is used, be sure to remove any remaining flux after finishing to soldering operation (This does not apply in the case of a non-halogen type of flux). It is recommended that you protect the LCD surface with a cover during soldering to prevent any damage due to flux spatters.

4.3.2 When soldering the electroluminescent panel and PC board, the panel and board should not be detached more than three times. This maximum number is determined by the temperature and time conditions mentioned above, though there may be some variance depending on the temperature of the soldering iron.

4.3.3 When remove the electroluminescent panel from the PC board, be sure the solder has completely melted, the soldered pad on the PC board could be damaged.

### 4.4 Precautions for Operation

4.4.1 Viewing angle varies with the change of liquid crystal driving voltage (VLCD). Adjust VLCD to show the best contrast.

4.4.2 It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life. An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided

4.4.3 Response time will be extremely delayed at lower temperature than the operating temperature range and on the other hand at higher temperature LCD's show dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, which will come back in the specified operating temperature.

4.4.4 If the display area is pushed hard during operation, the display will become abnormal. However, it will return to normal if it is turned off and then back on.

4.4.5 A slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit. Usage under the maximum operating temperature, 50%RH or less is required.

4.4.6 Input logic voltage before apply analog high voltage such as LCD driving voltage when power on. Remove analog high voltage before logic voltage when power off the module. Input each signal after the positive/negative voltage becomes stable.

4.4.7 Please keep the temperature within the specified range for use and storage. Polarization degradation, bubble generation or polarizer peel-off may occur with high temperature and high humidity.

#### 4.5 Safety

- 4.5.1 It is recommended to crush damaged or unnecessary LCDs into pieces and wash them off with solvents such as acetone and ethanol, which should later be burned.
- 4.5.2 If any liquid leaks out of a damaged glass cell and comes in contact with the hands, wash off thoroughly with soap and water.

#### 4.6 Limited Warranty

Unless agreed between Multi-Inno and the customer, Multi-Inno will replace or repair any of its LCD modules which are found to be functionally defective when inspected in accordance with Multi-Inno LCD acceptance standards (copies available upon request) for a period of one year from date of production. Cosmetic/visual defects must be returned to Multi-Inno within 90 days of shipment. Confirmation of such date shall be based on data code on product. The warranty liability of Multi-Inno limited to repair and/or replace on the terms set forth above. Multi-Inno will not be responsible for any subsequent or consequential events.

#### 4.7 Return LCM under warranty

- 4.7.1 No warranty can be granted if the precautions stated above have been disregarded. The typical examples of violations are :

- 4.7.1.1 - Broken LCD glass.
- 4.7.1.2 - PCB eyelet is damaged or modified.
- 4.7.1.3 -PCB conductors damaged.
- 4.7.1.4 - Circuit modified in any way, including addition of components.
- 4.7.1.5 - PCB tampered with by grinding, engraving or painting varnish.
- 4.7.1.6 - Soldering to or modifying the bezel in any manner.

- 4.7.2 Module repairs will be invoiced to the customer upon mutual agreement. Modules must be returned with sufficient description of the failures or defects. Any connectors or cable installed by the customer must be removed completely without damaging the PCB eyelet, conductors and terminals.

### ■ PACKING SPECIFICATION

Please consult our technical department for detail information.

### ■ PRIOR CONSULT MATTER

- 1 For Multi-Inno standard products, we keep the right to change material, process ... for improving the product property without prior notice to our customer.
- 2 For OEM products, if any changes are needed which may affect the product property, we will consult with our customer in advance.
- 3 If you have special requirement about reliability condition, please let us know before you start the test on our samples.